IN THE SPECIFICATION

Please amend the paragraph beginning at page 9, line 17, as follows:

The inventors of the present invention have made efforts to investigation to find a cause of increase in diameter of the via holes, etc. As a result, it has been proved that when the CO_2 laser has the wavelength as long as 10.6 μm, the spot diameter becomes large when the light is focused due to the influence of diffraction of laser beam and when an output is increased, the hole diameter becomes larger than the preset value.

Please amend the paragraph beginning at page 39, line 18, as follows:

In the above embodiment, the wavelength of CO_2 laser is ~~doubled~~ reduced to half by one tellurium crystal, but it is also possible to ~~increase~~ decrease the laser wavelength ~~fourfold~~ to quarter by providing the tellurium ~~crystal~~ crystals in two stages. Moreover, the CO_2 laser is used as the laser oscillator, but it is also possible in the present invention to use the harmonics of various laser sources such as argon, etc. Here, the wavelength of laser beam must be 360nm or less or 3000nm or more to bore the holes to the interlayer resin insulator. Namely, when the laser beam in the wavelength ~~larger~~ longer then 360nm and ~~smaller~~ shorter than 3000nm is used, ~~to eliminate generation of head~~ heat is not generated when the laser passes the resin. Therefore, when the wavelength is ~~doubled~~ reduced to half, the laser source of the wavelength ~~smaller~~ shorter than 720nm and ~~larger~~ longer than 6000nm must be used. Moreover, when the wavelength is ~~increased up~~ reduced to ~~four times~~ quarter, the laser source of the wavelength ~~smaller~~ shorter than 1440nm and ~~larger~~ longer than l2000nm must be used.